



General Description

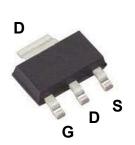
The TKMNM047 is the high cell density trenched N-ch MOSFETs, which provide excellent R_{DSON} and gate charge for most of the synchronous buck converter applications.

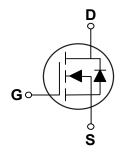
BV _{DSS}	R _{DS(ON)}	Ι _D
100 V	47 mΩ	6 A

Features

- $\cdot R_{DS(ON)} \leq 47 m\Omega @V_{GS} = 10V$
- · Super Low Gate Charge
- Excellent CdV/dt effect decline
- · Green Device Available

SOT-223 Pin Configuration





Applications

- Networking
- Load Switch
- LED applications

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current - Continuous (T _A =25°C)	6	Α
ıD	Drain Current - Continuous (T _A =70°C)	4.7	Α
I _{DM}	Pulsed Drain Current (NOTE 1)	24	Α
EAS	Single Pulse Avalanche Energy (NOTE 2)	11.3	mJ
IAS	Avalanche Current	15	Α
P_{D}	Power Dissipation (T _A =25°C) (NOTE 3)	1.5	W
T_J	Operating Junction Temperature Range	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
Marking Code		NM047 , L0016	

Thermal Characteristics					
Symbol	Parameter	Тур.	Max.	Unit	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient (Steady State)		70	°C/W	





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V
I _{DSS} Drain-Source Leakage Current	Drain Source Leekage Current	V_{DS} =80V , V_{GS} =0V , T_J =25 $^{\circ}$ C			10	uA
	Drain-Source Leakage Guirent	V_{DS} =80V , V_{GS} =0V , T_J =55 $^{\circ}$ C			100	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	IStatic Drain-Source On-Resistance	V _{GS} =10V , I _D =5A			47	mΩ
		V _{GS} =4.5V , I _D =5A			50	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	1.2		2.5	V
gfs	Forward Transconductance	V _{DS} =5V , I _D =5A		6.2		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge			60		
Q_gs	Gate-Source Charge	V_{DS} =80V , V_{GS} =10V , I_{D} =5A		9.2		nC
Q_{gd}	Gate-Drain Charge			9.9		
$T_{d(on)}$	Turn-On Delay Time			10.8		
T_r	Rise Time	V_{DD} =50V , V_{GS} =10V , R_{G} =3.3 Ω ,		27		nS
$T_{d(off)}$	Turn-Off Delay Time	I _D =3A		56		113
T_f	Fall Time			24		
C _{iss}	Input Capacitance			3848		
C _{oss}	Output Capacitance	V_{DS} =15V , V_{GS} =0V , F=1MHz		137		pF
C_{rss}	Reverse Transfer Capacitance			82		

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current (NOTE 4)	-V _G =V _D =0V , Force Current			6	Α
I _{SM}	Pulsed Source Current (NOTE 1 \ 4)				24	Α
V_{SD}	Diode Forward Voltage (NOTE 1)	V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C			1.2	V
t _{rr}	Reverse Recovery Time	I _F =5A,dI/dt=100A/us,T _J =25°C		25		nS
Q_{rr}	Reverse Recovery Charge			29		nC

NOTES:

- 1. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 2. The EAS data shows Max. rating. The test condition is V_{DD} =25V, V_{GS} =10V, I_{AS} =15A, L=0.1mH.
- 3. The power dissipation is limited by 150°C junction temperature.
- 4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.





Characteristics Curves

FIG.1-Typical Output Characteristics

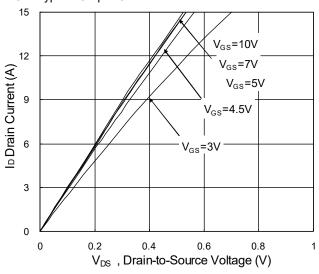


FIG.2-On-Resistance vs. G-S Voltage

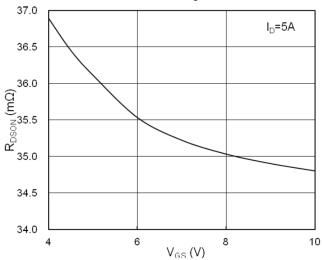


FIG.3-Forward Characteristics Of Reverse Diode

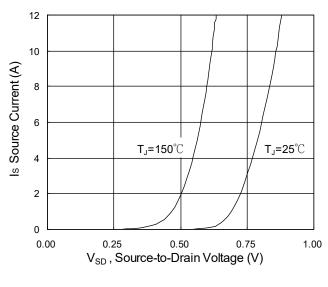


FIG.4-Gate Charge Characteristics

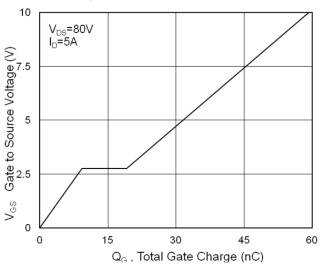


FIG.5-Normalized V_{GS(th)} vs. T_J

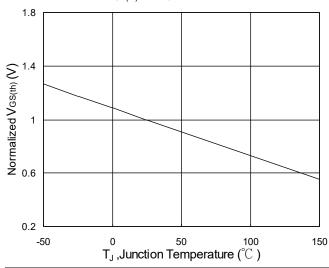
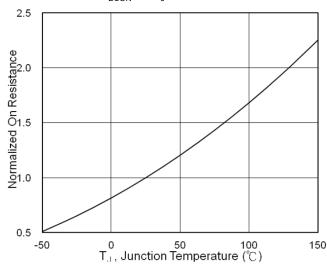


FIG.6-Normalized $R_{\text{DSON}}\,\text{vs.}\,T_{\text{J}}$







Characteristics Curves

FIG.7-Switching Time Waveform

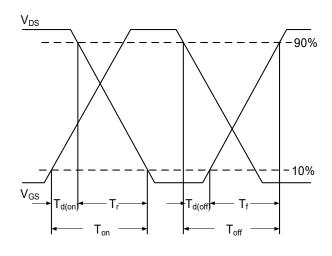
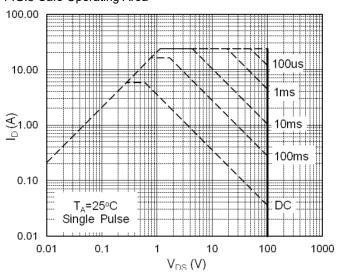
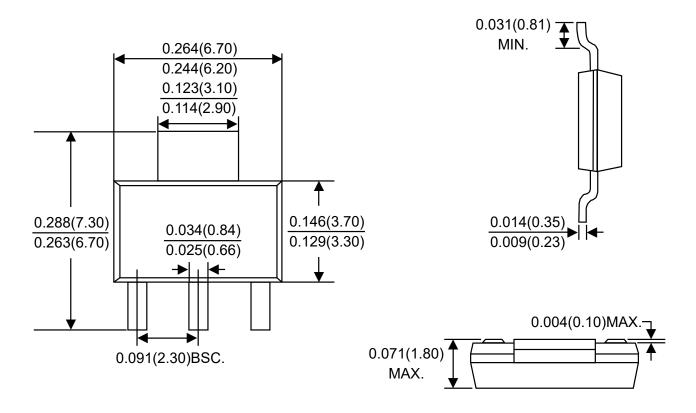


FIG.8-Safe Operating Area



Package Outline Dimensions



SOT-223Dimensions in inches and (millimeters)





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